

**IN THE CLAIMS:**

The status of the claims is as follows:

1. (currently amended) A device comprising:

a frame provided with ~~walls~~ an outer side wall and leg sections extending from said walls, ~~said device further comprising; and~~

a printed circuit board having a plurality of spaced holes, extending perpendicularly to said walls, wherein said leg sections extending through respective holes and being soldered to said printed circuit board so as to couple said frame extend through holes in said printed circuit board and are connected to the said printed circuit board by means of solder, wherein said printed circuit board having a part provided with at least one of said spaced holes outer side wall of said frame is provided with at least one leg section which extends through a hole located in a part of said printed circuit board, which part extends and extending through said outer side wall.

2. (currently amended) ~~[[A]] The high-frequency device as claimed in~~ of claim 1, wherein said outer side wall is provided with at least one cut-out part, in which said leg section is located and through which the said part of the said printed circuit board extends upon coupling said frame to said printed circuit board.

3. (currently amended) ~~[[A]] The high-frequency device as claimed in~~ of claim 1 or 2, wherein all said frame further comprises a plurality of outer side walls are each provided with respective leg sections, said leg sections extending through respective holes located in respective parts of the printed circuit board, which extend through said outer side walls.

4. (new) The high frequency device as claimed of 1, wherein said frame further comprises one or more inner walls bridging said outer side wall and provided with respective leg sections.

5. (new) The high frequency device of claim 4, wherein said printed circuit board frame comprises inner and outer parallel surfaces delimited by said outer side wall and having one or more second throughgoing holes of said plurality of spaced holes, said throughgoing holes

being configured to receive respective leg sections of said frame upon coupling said frame to said printed circuit board.

6. (new) The high frequency device of claim 1, wherein said printed circuit board extends perpendicular to the outer side wall of said frame upon coupling said frame to said printed circuit board.

7. (new) A high frequency device comprising:

a frame provided with a side wall;

a printed circuit board having a plurality of spaced peripheral extensions, said side wall of said frame and said peripheral extensions comprising respective formations engaging one another upon coupling said frame to said printed circuit board.

8. (new) The high frequency device of claim 7, wherein the formations include a plurality of holes and a plurality of leg sections configured to extend through the holes upon coupling said frame to said printed circuit board.